

DOCKET NO.: 197033US 28859-0-PCT

IN THE UNITED STATES PATENT & TRADEMARK OFFICE

IN RE APPLICATION OF: :  
YASUKI MIURA ET AL : GROUP ART UNIT: 1711  
SERIAL NO.: 09/623,486 :  
FILED: SEPTEMBER 15, 2000 : EXAMINER: ACQUAH, S.  
FOR: RESIN COMPOSITION :

#71B  
RECEIVED  
DEC 28 2001  
TC 1700

AMENDMENT AND REQUEST FOR RECONSIDERATION

ASSISTANT COMMISSIONER FOR PATENTS  
WASHINGTON, D.C. 20231

SIR:

In response to the Office Action dated September 21, 2001, please reconsider the application in view of the following amendment and remarks.

IN THE CLAIMS

Please cancel Claims 3 and 5 without prejudice to their further presentation in a Continuation application.

Please amend the Claims as follows.

1. (Amended) A resin composition which comprises the following (a) and the following (b) in a ratio of from 70 to 95 wt% of (a) and from 0.5 to 50 wt% of (b) in the total amount of (a) and (b):

(a) a polyphenylene sulfide; and

(b) a tetrafluoroethylene/perfluoro(alkylvinyl ether) copolymer or a tetrafluoroethylene/hexafluoropropylene copolymer having a solidification temperature ( $T_{mc}$ ) of at least 237°C when cooled at a cooling rate of 10°C/min after melting in a nitrogen

Re  
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